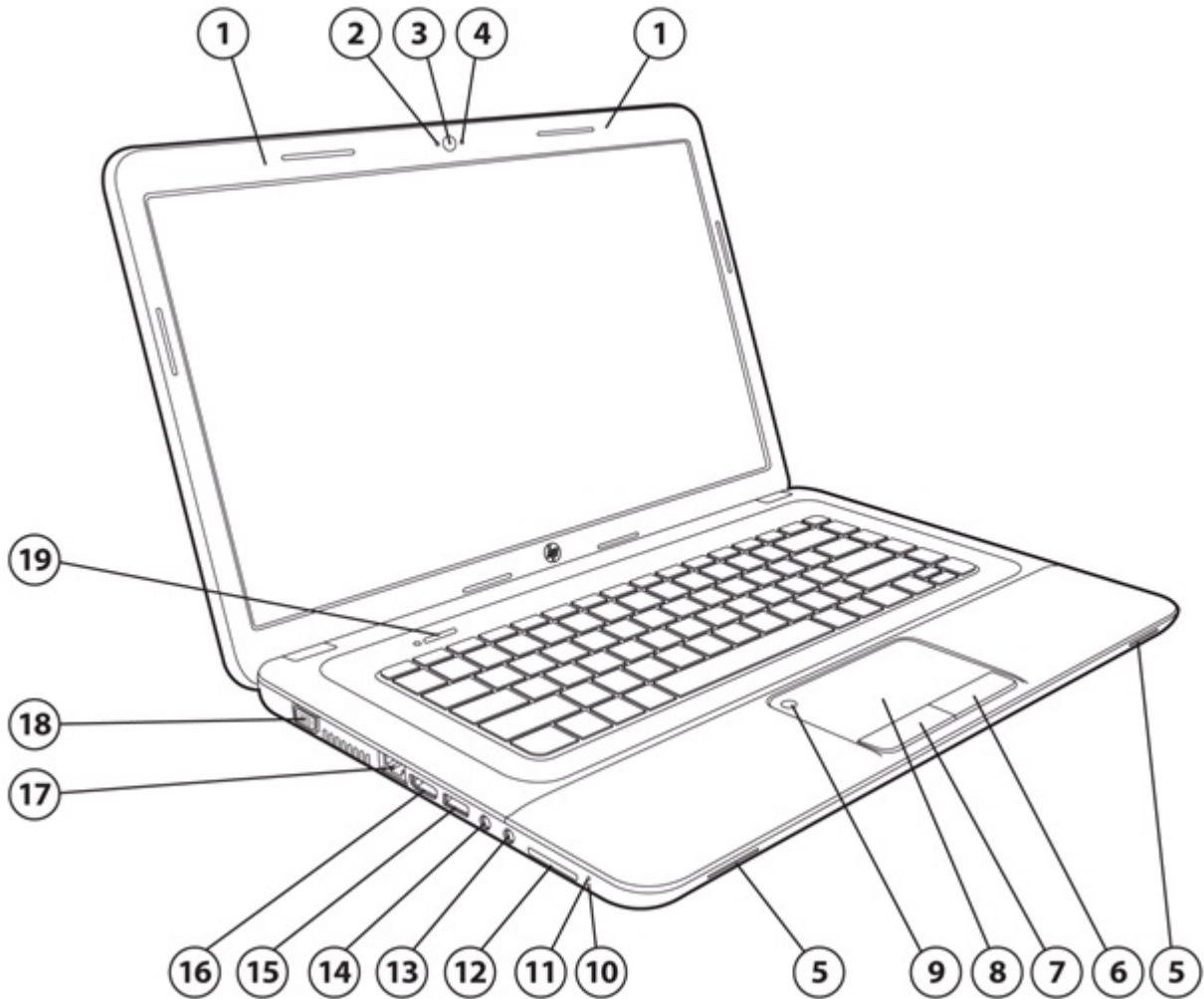
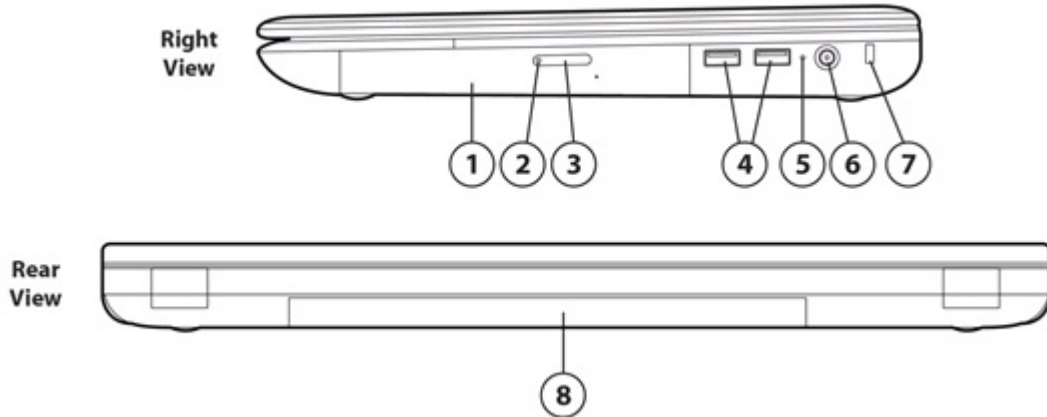


Overview

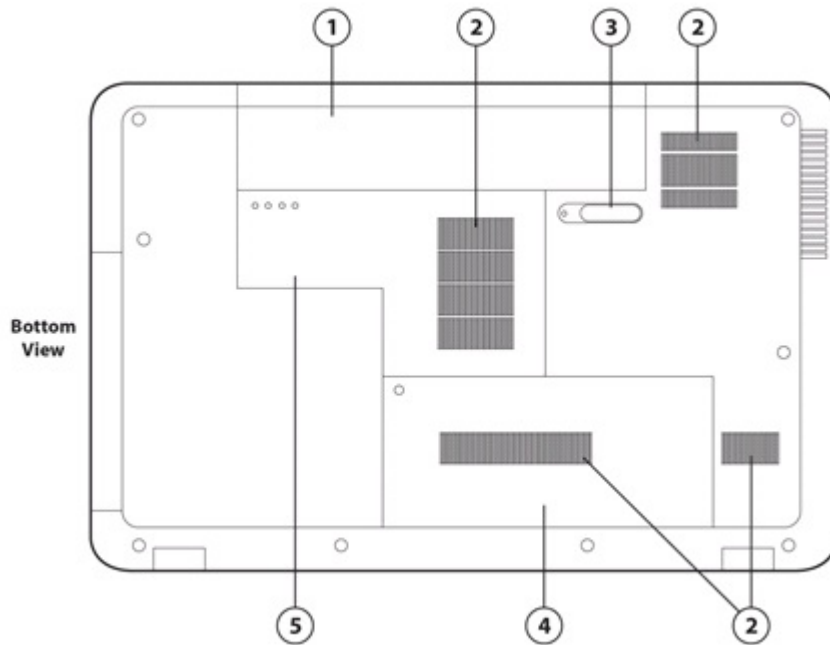


- | | |
|---------------------------------------|---------------------------------|
| 1. WLAN antennas (select models only) | 11. Power light |
| 2. Webcam light | 12. Digital media slot |
| 3. Webcam | 13. Audio-out (headphone) jacks |
| 4. Internal microphone | 14. Audio-in (microphone) jack |
| 5. Stereo speakers | 15. USB port |
| 6. Right TouchPad button | 16. HDMI port |
| 7. Left TouchPad button | 17. RJ-45 (Ethernet) |
| 8. Touchpad with scroll zone | 18. External monitor port |
| 9. TouchPad on/off button | 19. Power button |
| 10. Hard drive light | |

Overview



- | | |
|-------------------------------|------------------------|
| 1. Optical drive | 5. AC adaptor light |
| 2. Optical drive light | 6. Power connector |
| 3. Optical drive eject button | 7. Security cable slot |
| 4. USB ports | 8. Battery bay |



- | | |
|--------------------------|--|
| 1. Battery bay | 4. Hard drive bay compartment |
| 2. Vents | 5. Wireless compartment, and memory module compartment, keyboard screw, and optical drive bay. |
| 3. Battery release latch | |

Overview

At A Glance

- Windows 8 versions, Ubuntu Linux, FreeDOS 2.0*
- Intel® HD Graphics Family with shared memory
- Durable, sophisticated design with smooth surfaced charcoal color.
- Full-sized keyboard with action keys enabling functions directly
- HDMI port for connecting to high-resolution displays
- Integrated HD webcam, integrated microphone
- Optional 802.11 b/g/n 1x1 wireless LAN module**Bluetooth™ 2.1 or Bluetooth™ 4.0**
- 15.6" diagonal LED-backlit HD anti-glare display

* Operating system options vary by country.

** Select models only (BT4.0 supports under Windows 8 OS only, BT2.1 supports under Linux)

Features

OPERATING SYSTEM

Preinstalled	Windows 8 64*
	Windows 8 Pro 64*
	Ubuntu Linux
	FreeDOS 2.0

* Not all features are available in all editions of Windows 8. Systems may require upgraded and/or separately purchased hardware, drivers and/or software to take full advantage of Windows 8 functionality. See <http://www.microsoft.com> for details.

PROCESSOR

- 3rd Generation Intel® Core™ i5-3230M (2.6 GHz, 3 MB L3 cache, 2 cores)*
Up to 3.20 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i5-3210M (2.5 GHz, 3 MB L3 cache, 2 cores)*
Up to 3.10 GHz with Intel Turbo Boost Technology
- 3rd Generation Intel® Core™ i3-3130M (2.6 GHz, 3 MB L3 cache, 2 cores)*
- 3rd Generation Intel® Core™ i3-3120M (2.5 GHz, 3 MB L3 cache, 2 cores)*
- 3rd Generation Intel® Core™ i3-3110M (2.4 GHz, 3 MB L3 cache, 2 cores)*
- 2nd Generation Intel® Core™ i3-2348M (2.3 GHz, 3 MB L3 cache, 2 cores) *
- 2nd Generation Intel® Core™ i3-2328M (2.2 GHz, 3 MB L3 cache, 2 cores) *
- Intel® Pentium® 2030M (2.5 GHz, 2 MB L3 cache, 2 cores)*
- Intel® Pentium® 2020M (2.4 GHz, 2 MB L3 cache, 2 cores)*
- Intel® Pentium® B980 (2.4 GHz, 2 MB L3 cache, 2 cores) *
- Intel® Pentium® B970 (2.3 GHz, 2 MB L3 cache, 2 cores)*
- Intel® Pentium® B960 (2.2 GHz, 2 MB L3 cache, 2 cores)*
- Intel® Celeron® 1000M (1.8 GHz, 2 MB L3 cache, 2 cores)*
- Intel® Celeron® B830 (1.8 GHz, 2 MB L3 cache, 2 cores)

* Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

CHIPSET

- Mobile Intel® HM70 Express (Intel® Pentium and Celeron processors)
- Mobile Intel® HM75 Express (Intel® Core™ i3 and i5 processors)

GRAPHICS

- Integrated: Intel® HD Graphics
- Intel® HD Graphics (Intel® Pentium® or Intel® Celeron® processor)
- Intel® HD Graphics 3000 (2nd Generation Intel® Core™ i3, i5 processor)
- Intel® HD Graphics 4000 (3rd Generation Intel® Core™ i3, i5 processor)

Features

DISPLAY

Internal

15.6" diagonal LED-backlit HD 16:9 widescreen anti-glare (1366 x 768)

External

Up to 32-bit per pixel color depth

VGA

Port supports resolutions up to 2048 x 1536 external resolution @75 Hz

HDMI*

1.4 port supports up to 1080p, 1920 x 1080 at 60Hz

* HD content required to view HD images.

** HDMI cable sold separately.

NOTE: Resolutions are dependent upon monitor capability, and resolution and color depth settings.

STORAGE AND DRIVES

Primary Storage Bay**Hard Drives**

320/500/640/750 GB 5400 rpm SMART SATA II

NOTE: For hard drives, GB = 1 billion bytes. Actual formatted capacity is less. Up to 36 GB (for Windows 8) of system disk is reserved for the system recovery software.

OPTICAL DRIVES

Fixed 12.7 mm SATA Optical Drive

DVD+/-RW SuperMulti DL* Drive

Weight saver

* Double-layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. Note that DVD-RAM cannot read or write to 2.6 GB single-sided/5.2 GB double-sided - version 1.0 media. Don't copy copy-right protected materials.

MEMORY

Standard

DDR3 SDRAM (1600 MHz) or DDR3/3L SDRAM (1600 MHz)

Two SODIMM slots supporting dual-channel memory

Standard memory up to 6144 MB

Maximum

Upgradeable to 8192 MB with optional 2048/4096 MB SODIMMs in slots 1 and 2

Dual-channel

Maximized dual-channel performance requires SODIMMs of the same size and speed in both memory slots.

NOTE: Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed. With Windows Starter 32-bit operating systems, the amount of usable memory is dependent upon your configuration, so that above 3 GB all memory may not be available due to system resource requirements.

Features

NETWORKING/COMMUNICATIONS

Wireless

Qualcomm 802.11 b/g/n (1x1) wireless LAN module²

Optional: Ralink 802.11 b/g/n (1x1) + Bluetooth™ 4.0 combo^{2,1,4}

Bluetooth™ 2.1^{3,2,1} or Bluetooth™ 4.0^{4,2,1}

Communications

Realtek Ethernet (10/100/1000 NIC)

1. Sold separately or as an optional feature.
2. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.
3. Bluetooth™ 2.1 is available on Linux operating system.
4. Bluetooth™ 4.0 is available on Windows 8 operating system only.

NOTE: In countries where 802.11n is not allowed, this capability is not enabled.

AUDIO/MULTIMEDIA

Audio

High Definition Audio support

Integrated Altec Lansing Stereo Speaker

Stereo headphone/line out

Stereo microphone in,

Integrated microphone

Webcam

Integrated HD* Webcam**

- Supports videoconferencing and still image capture
- Improved quality for video streaming and still image capture (1280x720 resolution)
- Up to 30 frames/sec
- Fixed focus lens

* HD content required to view HD images.

** Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited.

Features

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

The 100% compatible keyboard features a, industry standard, full-pitch key layout with features such as the isolated inverted-T cursor control keys, editing keys, both left and right control and alt keys, and 12 function keys. International key layouts are available. Other features include hotkeys for instant access to, brightness, etc. 19-mm x 19-mm key pitch (center-to-center spacing), 2.2-mm stroke, comfort-dished keycaps, and bright key legends for improved visibility in low light conditions.

Pointing Devices

Touchpad with 2-piece pick button with left and right click functions

Multi-touch gestures supported

Buttons and Function Keys

On/off button

SOFTWARE AND SECURITY

Preinstalled Software with Windows Operating System

Buy Office

Recovery Manager Installer

Cyberlink Youcam DE

Cyberlink Power DVD (available on select models)

Symantec Norton™ Internet Security 2013*

Getting Started with Win 8

Security

Security Lock slot (lock must be purchased separately)

* Internet access required. This product includes Norton software. First 60 days included. Subscription required for live updates afterward.

NOTE: Computrace® agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging from one to five years. Service is limited, check with Absolute for availability outside the U.S.

For more information on HP security solutions refer to: <http://www.hp.com/go/security>.

Features

POWER

Power Supply

External 65W HP AC adapter

Primary Battery

HP 6-cell (47 WHr) Li-Ion battery

Battery life up to 6.5 hours*

System Standby Time

Up to 1 week

* Battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See www.bapco.com for additional details.

NOTE: Fast Charge recharges your battery up to 90% within 90 minutes when the system is off. The HP Fast Charge is only for 6 cell/47 WHr battery pack.

Power Conservation

Hibernation*

Standby*

ACPI compliance*

* Only Linux will feature power conservation.

WEIGHTS & DIMENSIONS

Weight

Starting at 5.39 lb (2.45 kg)

Dimensions (w x d x h)

14.80 x 9.72 x 1.41 in

37.6 x 24.7 x 3.58 cm

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes 6-cell battery, hard drive, 1 GB memory, and optical drive.

Features

PORTS/SLOTS

Ports

VGA – One

HDMI* – One

Stereo microphone in – One

Stereo headphone/line out – One

Power Connector – One

RJ-45 (Ethernet) – One

USB 2.0 – Three

Digital Media Slots

Supports SD (Secure Digital)

Supports mini versions with adapter

* HDMI cable sold separately.

SERVICE AND SUPPORT

HP Services offers limited 1-year warranty options depending on country;

1-year limited warranty on primary battery. On-site service and warranty upgrades are also available. HP Care Pack Services* extend service contracts beyond the standard warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: <http://www.hp.com/go/cpc>. Additional HP Care Pack Services information by product is available at: <http://www.hp.com/hps/carepack>.

* Service levels and response times for HP Care Packs may vary depending on your geographic location. Restrictions and limitations apply. Service starts at date of hardware purchase. For details, visit <http://www.hp.com/go/cpc>

NOTE: Certain restrictions and exclusions apply. Consult the HP Customer Support Center for details.

<http://h20000.www2.hp.com/bizsupport/TechSupport/ProductRoot.jsp>

Technical Specifications

SYSTEM UNIT

Dimensions 14.8 x 9.72 x 1.41 in
(w x d x h) 37.6 x 24.7 x 3.58 cm

Weight Starting at 5.39 lb (2.45 kg)

NOTE: Height varies depending upon where on the notebook the measurement is made. Weight varies by configuration and components. Weight includes 6-cell battery, hard drive, 1 GB memory, and optical drive.

Stand-Alone Power Requirements (AC Power) **Nominal Operating Voltage** 18.5/19.5V

Average Operating Power Integrated graphics: 12.741 W***
*Support models with Intel® HM75/HM70 Express Chipset

Max Operating Power < 65 W

Temperature **Operating** 32° to 95° F (0° to 35° C) (not writing optical)
41° to 95° F (5° to 35° C) (writing optical)

Non-operating -4° to 140° F (-20° to 60° C)

Relative Humidity **Operating** 10% to 90%, non-condensing

Non-operating 5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature

Shock **Operating** 40 G, 2 ms, half-sine

Non-operating 200 G, 2 ms, half-sine

Random Vibration **Operating** 0.75 grms

Non-operating 1.50 grms

Altitude (unpressurized) **Operating** -50 to 10,000 ft (-15.24 to 3,048 m)

Non-operating -50 to 40,000 ft (-15.24 to 12,192 m)

Planned Industry Standard Certifications **UL** Yes

CSA Yes

FCC Compliance Yes

ENERGY STAR® Select models*

EPEAT Registered Silver in United States**

ICES Yes

Australia / NZ A-Tick Compliance Yes

CCC Yes

Japan VCCI Compliance Yes

KC Yes

BSMI Yes

CE Marking Compliance Yes

BNCI or BELUS Yes

CIT Yes

GOST Yes

Saudi Arabian Compliance (ICCP) Yes

Technical Specifications

SABS	Yes
UKRSERTCOMPUTER	Yes

* Configurations of the HP 250 that are ENERGY STAR qualified are identified as HP 250 ENERGY STAR on HP websites and on www.energystar.gov.

** EPEAT registration varies by country. See www.epeat.net for registration status by country. EPEAT status listed above applies to U.S.

For accessibility information on HP products, please visit: <http://www.hp.com/accessibility>.

DISPLAY

15.6-inch LED HD (1366 x 768) Anti-glare	Active Area (w x h)	13.54 x 7.59 in (34.4 x 19.4 cm)	
	Diagonal Size	15.6 in (39.6cm)	
	Surface Treatment	Anti-glare	
	Contrast Ratio	300:1 (min)	
	Refresh Rate	60 Hz	
	Brightness	200 nit (typical)	
	Pixel Resolution	Pitch	0.252 mm
		Format	1366 x 768
		Configuration	RGB Stripe
	Backlight	LED	
	PPI	101 ppi	
Viewing Angle	±40° Horizontal, ±10°/-30° Vertical (minimum) 40/40/30/10 (Left/Right/Down/Up)		

STORAGE AND DRIVES

Internal Storage

Technical Specifications

750 GB 5400 rpm SATA Hard Drive

Drive Weight	0.22 lb (101 g)
Capacity	750 GB
Height	0.37 in (9.5 mm)
Width	2.75 in (70 mm)
Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ
Transfer Rate	Synchronous (maximum) 300 MB/s (Drive Capability)
Seek Time (typical reads, including settling)	Single Track 3 ms
	Average 13 ms
	Maximum 24 ms
Rotational Speed	5400 rpm
Logical Blocks	1,465,149,168
Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security

640 GB 5400 rpm SATA Hard Drive

Drive Weight	0.22 lb (101 g)
Capacity	640 GB
Height	0.37 in (9.5 mm)
Width	2.75 in (70 mm)
Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ
Transfer Rate	Synchronous (maximum) 150 MB/s (Drive Capability)
Seek Time (typical reads, including settling)	Single Track 3 ms
	Average 13 ms
	Maximum 24 ms
Rotational Speed	5400 rpm
Logical Blocks	1,250,263,728
Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security

Technical Specifications

500 GB 5400 rpm SATA Hard Drive

Drive Weight	0.22 lb (101 g)
Capacity	500 GB
Height	0.37 in (9.5 mm)
Width	2.75 in (70 mm)
Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ
Transfer Rate	Synchronous (maximum) 150 MB/s (Drive Capability)
Seek Time (typical reads, including settling)	Single Track 3 ms
	Average 13 ms
	Maximum 24 ms
Rotational Speed	5400 rpm
Logical Blocks	976,773,168
Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security

320 GB 5400 rpm SATA Hard Drive

Drive Weight	0.22 lb (101 g)
Capacity	320 GB
Height	0.37 in (9.5 mm)
Width	2.75 in (70 mm)
Interface	ATA-8, SATA 2.6, 3.0 Gb/s, NCQ
Transfer Rate	Synchronous (maximum) 150 MB/s (Drive Capability)
Seek Time (typical reads, including settling)	Single Track 3 ms
	Average 13 ms
	Maximum 24 ms
Rotational Speed	5400 rpm
Logical Blocks	625,142,448
Operating Temperature	32° to 140° F (0° to 60° C) [case temp]
Features	ATA Security

Optical Drives

Technical Specifications

DVD+/-RW SuperMulti DL Drive	Access Times	Random	<140ms CD (typical) < 160 ms DVD (typical)
	Max Data Transfer Rate	24X CD-ROM 8X DVD 24X CD-R 24X CD-RW 8X DVD+R 8X DVD+RW 8X DVD-R 6X DVD-RW 5X DVD-RAM	
	Transfer Mode	UDMA Mode 5	
	Interface	Gen 1 SATA	
	Supported Media (read)	CD-DA, CD-TEXT, CD-ROM, CD-ROM XA, MIXED MODE CD, CD-I, CD-I Bridge (Photo-CD, Video CD), Multisession CD (Photo-CD, CD-EXTRA, Portfolio, CD-R, CD-RW), CD-R, CD-RW, DVD-ROM (DVD-5, DVD-9, DVD-10, DVD-18), DVD-R, DVD-RW, DVD+R, DVD+RW, DVD-RAM	
	Supported Media (write)	CD-R, CD-RW, DVD+R, DVD+RW, DVD-R, DVD-RW, DVD-RAM, DVD+R DL, DVD-R DL	
	Max Media Capacity (read)	8.5 GB	
	Max Media Capacity (write)	8.5 GB	
	Transport	Tray Loading	

NETWORKING/COMMUNICATIONS

Networking

Integrated Realtek RTL8161FH-CG 10/100/1000 NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21-30) 1000 Mbit/s operation (100BASE-T; IEEE 802.3ab; IEEE 802.3 clauses 21-30) (Support in RTL8161FH-CG only) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s IEEE 802.1p QoS (Quality of Service) Support IEEE 802.1q VLAN support IEEE 802.3x Flow Control (IEEE 802.3 clauses 31-32; configurable)
	Power Management	ACPI compliant - multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Large send offload and Giant send offload Receiving Side Scaling

Technical Specifications

Manageability	Wake-on-LAN from standby and hibernation (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
Interface	PCI Express 1.1 x1 to fully support ASPM L0s/L1 and CLKREQ
NIC Device Driver Name	Realtek PCIe FE Ethernet Family Controller

Communications

Ralink 802.11b/g/n Bluetooth 4.0 Combo Card	Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
	Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows7 (details at: http://www.hp.com/go/notebooks/WLAN)
	Frequency Band	2.402 – 2.482 GHz
	Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: 150Mbps for MCS7
	Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
	Security¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST. WAPI Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 5) with Microsoft Windows Vista and XP only.
	Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
	Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power (for CCK)²	13.5dBm , minimum
	Power Consumption	Idle associated: 250 mW Idle unassociated: 150 mW Transmit: 2.0 W (max) Receive: 2.0 W (max)
	Power Management	ACPI compliant power management 802.11 compliant power saving mode
	Receiver Sensitivity³	11b:-88dBm@11Mbps, 11g:-74 dBm@54Mbps, 11n:-70dBm@72.Mbps.

Technical Specifications

Antenna type	High efficiency dual antenna with spatial diversity, mounted in the display enclosure	
Form Factor	PCI-Express Half-MiniCard	
Weight	6 g	
Dimensions	3.3 x 26.65 x 29.85 mm	
Operating Voltage	3.3v +/- 10%	
Temperature	Operating	14° to 149° F (-10° to 65° C)
	Non-operating	-40° to 176° F (-40° to 80° C)
Humidity	Operating	10% to 90% (non-condensing)
	Non-operating	5% to 95% (non-condensing)
Altitude	Operating	0 to 10,000 ft (3,048 m)
	Non-operating	0 to 50,000 ft (15,240 m)
LED Activity	LED Off – Radio OFF; Solid LED On – RadioON	
	<ol style="list-style-type: none"> 1. Check latest software/driver release for updates on supported security features. 2. Maximum output power may vary by country according to local regulations. 3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation). 	

NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista and Win7.

Ralink 802.11b/g/n Bluetooth 4.0 Combo Card

Wireless LAN Standards	IEEE 802.11b IEEE 802.11g IEEE 802.11n
Interoperability	Wi-Fi certified Cisco Compatible Extensions Program compliant with Microsoft Windows7 (details at: http://www.hp.com/go/notebooks/WLAN)
Frequency Band	2.402 – 2.482 GHz
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps
	802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
	802.11n: card will support rates for NSS=1 for RX and TX for 20 MHz channels. Short and long guard intervals shall be supported
Modulation	Direct Sequence Spread Spectrum DBPSK, DQPSK, CCK, OFDM, BPSK, QPSK, 16-QAM, 64-QAM
Security¹	Supports 64- and 128-bit WEP, WPA, WPA2, hardware-accelerated AES, 802.1x authentication types EAP-TLS, EAP-TTLS, PEAP-GTC, PEAP-MSCHAPv2, LEAP, EAP-FAST. WAPI
	Support for Cisco Security Features (proven compatibility with Cisco Aironet infrastructure products through the Cisco Compatible Extensions Program Version 5) with Microsoft Windows Vista and XP only.
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.
Media Access Protocol	CSMA/CA (Collision Avoidance) with ACK

Technical Specifications

Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
Roaming	IEEE 802.11 compliant roaming between access points
Output Power (for CCK)²	13.5dBm, minimum
Power Consumption	Idle associated: 250 mW Idle unassociated: 150 mW Transmit: 2.0 W (max) Receive: 2.0 W (max)
Power Management	ACPI compliant power management 802.11 compliant power saving mode
Receiver Sensitivity³	72.2 Mbps: -70 dBm; 54 Mbps: -74 dBm; 11 Mbps: -88 dBm ; 1 Mbps: -95 dBm
Antenna type	High efficiency dual antenna with spatial diversity, mounted in the display enclosure
Form Factor	PCI-Express Half-MiniCard
Weight	6 g
Dimensions	3.3 x 26.65 x 29.85 mm
Operating Voltage	3.3v +/- 10%
Temperature	Operating 14° to 149° F (-10° to 65° C) Non-operating -40° to 176° F (-40° to 80° C)
Humidity	Operating 10% to 90% (non-condensing) Non-operating 5% to 95% (non-condensing)
Altitude	Operating 0 to 10,000 ft (3,048 m) Non-operating 0 to 50,000 ft (15,240 m)
LED Activity	LED Off – Radio OFF; Solid LED On – Radio ON

1. Check latest software/driver release for updates on supported security features.
2. Maximum output power may vary by country according to local regulations.
3. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

NOTE: WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software suppliers. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista and Win7.

Bluetooth Specification

V4.0 High Speed, V2.1+EDR, backwards compatible with V1.1, 1.2 and 2.0

Number of Available Channels 79 (1 MHz) available channels

Data Rates and Throughput 3 Mbps data rate; throughput up to 2.17 Mbps

Synchronous Connection Oriented links up to 3, 64 kbps, voice channels

Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric or 1306.9 kbps symmetric

Transmit Power -6 dBm to 4 dBm (Bluetooth Class II)

Technical Specifications

Receiver Sensitivity	Better than -80 dBm at 0.1 % raw bit error rate
Power Consumption	Peak (Tx) 330 mW Peak (Rx) 230 mW Sleep <17 mW
Antenna	Internally integrated within module
Range	Up to 33 ft (10 m)
Electrical Interface	USB 2.0 compliant Microsoft Windows Plug and Play compliant
Bluetooth Software Supported	Broadcom Bluetooth for Windows Microsoft Windows Bluetooth Software
Link Topology	Point to Point, Multipoint Pico Nets up to 7 slaves
Security	Full support of Bluetooth Security Provisions
Power Management	Microsoft Windows ACPI, and USB Bus Support Self configurable to optimize power conservation in all operating modes, including Standby, Hold, Park, and Sniff
Certifications	All necessary regulatory approvals for supported countries, including: FCC (47 CFR) Part 15C, Section 15.247 & 15.249 ETS 300 328, ETS 300 826 Low Voltage Directive IEC950 UL, CSA, and CE Mark
Bluetooth Profiles Supported	Generic Access Profile (GAP) Service Discovery Application Profile (SDAP) Serial Port Profile (SPP) Dial_Up Networking Profile (DUN) Generic Object Exchange Profile (GOEP) Object Push Profile (OPP) File Transfer Profile (FTP) Synchronization Profile (SYNC) Hard Copy Cable Replacement (HCRP) Personal Area Networking Profile (PAN) Human Interface Device Profile (HID) Generic Audio/Video Distribution Profile (GAVDP) Advanced Audio/Video Distribution Profile (A2DP) FAX Profile (FAX) Basic Imaging Profile (BIP) Headset Profile (HSP) Hands Free Profile (HFP) Basic Printing Profile (BPP) VDP (Video Distribution Profile) AVRCP (Audio Video Remote Control Profile)

AUDIO/MULTIMEDIA

Audio



Technical Specifications

Hardware	Implementation	Realtek ALC3201-GR High Definition audio
	Volume Controls	Up, down, and mute function keys
	Full Duplex	Yes
	Microphone In	Stereo
	Headphone/Line Out	Stereo
	Integrated Microphone	Yes
Audio Output Quality	Frequency Response	10 Hz ~ 22 KHz
	Signal to Noise Ratio	Typical 95 dB FSA (DAC)
	Total Harmonic Distortion	Typical -88 dB FS (DAC)
	Noise Floor	-110 dB
	Play/Record Sampling Rate(s)	Up to 192 KHz
	DAC	24 bits
	ADC	24 bits
Internal Stereo Speakers	Power Rating	1.5 W
	Impedance	4 ohms
Multimedia		
Integrated HD Webcam	Supports videoconferencing and still image capture Improved quality for video streaming and still image capture (1280x720 resolution) Up to 30 frames/sec Fixed focus lens	

POWER

Technical Specifications

HP 65W AC Adapter	Dimensions	4.21 x 1.85 x 1.18 in (10.7 x 4.7 x 3.0 cm)	
	Weight	0.62 lb (280 g)	
	Input		100 to 240 VAC
		Input Efficiency	87% min at 115 VAC
		Input frequency range	47 to 63 Hz
	Output	Input AC current	1.7 A at 90 VAC
		Output power	65W
		DC output	18.5/19.5V
		Hold-up time	5 msec at 115 VAC input
		Output current limit	<11A, Over voltage protection- 29V max automatic shutdown
	Connector	3 pin/grounded, mates with interchangeable cords	
	Environmental Design	Operating temperature	41° to 95° F (5° to 35° C)
		Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
		Altitude	0 to 5,000 ft (0 to 1,524 m)
		Humidity	20% to 95%
Storage Humidity		10% to 95%	
EMI and Safety Certifications	CE Mark - full compliance with LVD and EMC directives; Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE; MTBF - over 200,000 hours at 25°C ambient condition.		
6-Cell (47 WHr) Lithium-Ion battery	Dimensions (h x w x l)	0.85 x 2.06 x 8.07 in (2.17 x 5.23 x 20.5 cm)	
	Weight	0.7 lb (0.327 kg)	
	Cells/Type	6-cell Lithium-Ion	
	Energy Temperature	Watt-hour capacity	47 WHr
		Operating (Charging)	32° to 113° F (0° to 45° C)
		Operating (Discharging)	14° to 140° F (-10° to 60° C)
		Non-operating	-4° to 140° F (-20° to 60° C)
	Battery Re-Charge Time	System in OFF or Standby Mode	2.5 hours
		System ON	3 to 5 hours (depending on system power consumption)
		HP Fast Charge Technology	Charges the battery up to 90% within 90 minutes when system is OFF

ENVIRONMENTAL

Technical Specifications

Environmental Data

Eco-Label Certifications This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

US Energy Star®
IT ECO declaration
EPEAT Silver

System Configuration The configuration used for the Energy Consumption and Declared Noise Emissions data is based on a "Typically Configured Notebook"

Energy Consumption	115 VAC	230 VAC	100 VAC
Normal Operation	10.23 W	10.46 W	10.01 W
Sleep (Energy Star low power mode)	0.64 W	0.67 W	0.64 W
Off	0.37 W	0.40 W	0.36 W

Heat Dissipation*	115 VAC	230 VAC	100 VAC
Normal Operation	35 BTU/hr	36 BTU/hr	34 BTU/hr
Sleep	2 BTU/hr	2 BTU/hr	2 BTU/hr
Off	1 BTU/hr	1 BTU/hr	1 BTU/hr

* Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions (in accordance with ISO 7779 and ISO 9296)

System Fan Off	Sound Power (LWAd, bels)	Sound Pressure (LpAm, decibels)
Idle	3.5	28
Fixed Disk (random writes)	3.5	28

System fan is usually off except when charging the battery

Batteries This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain:

- Mercury greater the 5ppm by weight
- Cadmium greater than 10ppm by weight

The battery type and chemistry used in the product is:

CR2032 (common) (Li-MNO2) = PANDA CR2032 lithium/manganese dioxide

Additional information

This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.

This HP product is designed to comply with the Waste Electrical and Electronic

Technical Specifications

Equipment (WEEE) Directive - 2002/96/EC.

This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).

This product is in compliance with the IEEE 1680 (EPEAT) standard at the Silver level, see www.epeat.net

Plastics parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.

This product contains 0% post-consumer recycled plastic (by wt.)

This product is greater than 97.10% recycle-able when properly disposed of at end of life.

Packaging Materials

- External:
 - PAPER/Corrugated 470.8 g
- Internal:
 - PLASTIC/Polyethylene low density 46.3 g
- The PAPER/Corrugated packing material is made from 70% recycled content
- The PLASTIC/Polyethylene low density packing materials contains at least 50% recycled content

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

MATERIAL USAGE

This product does not contain any of the following substances in excess of regulatory limits (for reference of these limits please refer to the HP General Specification of the Environment

(http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Certain Azo Colorants

Technical Specifications

- Certain Brominated Flame Retardants – may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- Lead carbonates and sulfates
- Lead and Lead compounds
- Mercuric Oxide Batteries
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
- Nickel finishes that release greater than 0.5 µgrams/cm²/week, measured according to EN 1811:1998, are not used on any product surface designed to be frequently handled or touched by users.

END-OF-LIFE MANAGEMENT AND RECYCLING

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <http://www.hp.com/go/reuse-recycle> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <http://www.hp.com/go/recyclers>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

HEWLETT-PACKARD CORPORATE ENVIRONMENTAL INFORMATION

For more information about HP's commitment to the environment:

Global Citizenship Report

<http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html>

Environment website

<http://www.hp.com/environment>

Eco-label certifications

<http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html>

ISO 14001 certificates:

<http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html>

COUNTRY OF ORIGIN

China

Options and Accessories (sold separately and availability may vary by country)

NOTE: Options/capabilities listed in the QuickSpecs represent those capabilities available through Base Units or Build to Order configurations. The various product features and capabilities will vary in terms of configurable vs. aftermarket options (AMOs). There may be options and capabilities available through CTO that are not available as AMOs.

Type	Description	Part #
Carrying Cases	HP Essential Top Load Case (up to 15.6")	H2W17AA#xxx
	HP Essential Backpack (up to 15.6")	H1D24AA
	HP Business 4 Wheel Roller Case	H5M93AA
Docking	HP USB 2.0 Port Replicator	H1L07AA#xxx
	HP USB 3.0 Port Replicator	H1L08AA#xxx
Input/Output	HP Stylish Wireless KB/Mouse	H4B79AA
	HP Stylish USB KB/Mouse	H4B80AA
Memory	HP 4GB DDR3 1600 PC3-12800 SODIMM	H2P64AA#xxx
Adapters	90W Slim Combo Adapter	H4A41AA#xxx
	90W w/USB Universal Adapter	H4A43AA#ABA
	90W Smart Auto/Truck Adapter	ED493AA
	HP 65W Slim Adapter	AX727AA#xxx
Batteries	HP MU06 Battery	H0F74AA#ABA
Security	HP Notebook Combo Lock	AY475AA#xxx
	HP UltraSlim Keyed Cable Lock	H4D73AA
Storage	HP Mobile USB DVDRW Non-LS	A2U57AA

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